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MJD32CT4-A

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MJD32CT4-A

Low voltage PNP power transistor

Datasheet – production data

Features

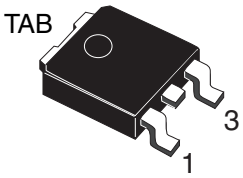
- This device is qualified for automotive application
- Surface-mounting TO-252 power package in tape and reel
- Complementary to the NPN type MJD31C

Application

- General purpose linear and switching equipment

Description

The device is manufactured in planar technology with “base island” layout. The resulting transistor shows exceptional high gain performance coupled with very low saturation voltage.



DPAK
TO-252

Figure 1. Internal schematic diagram

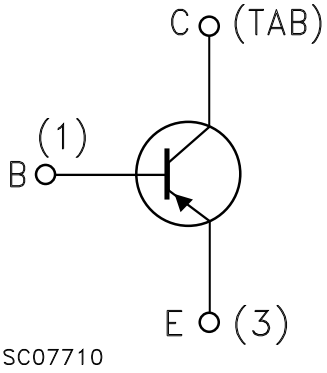


Table 1. Device summary

Order code	Marking	Package	Packaging
MJD32CT4-A	MJD32C	DPAK	Tape and reel

1 Electrical ratings

Table 2. Absolute maximum ratings

Symbol	Parameter	Value	Unit
V_{CBO}	Collector-base voltage (I_E = 0)	-100	V
V_{CEO}	Collector-emitter voltage (I_B = 0)	-100	V
V_{EBO}	Emitter-base voltage (I_C = 0)	-5	V
I_C	Collector current	-3	A
I_{CM}	Collector peak current	-5	A
I_B	Base current	-1	A
P_{TOT}	Total dissipation at T_c = 25 °C	15	W
T_{STG}	Storage temperature	-65 to 150	°C
T_J	Max. operating junction temperature	150	°C

Table 3. Thermal data

Symbol	Parameter	Value	Unit
R_{thJC}	Thermal resistance junction-case max	8.3	°C/W
R_{thJPCB} (1)	Thermal resistance junction-pcb max	50	°C/W

1. When mounted on FR-4 board of 1 inch², 2 oz Cu.

2 Electrical characteristics

T_{case} = 25 °C unless otherwise specified.

Table 4. Electrical characteristics

Symbol	Parameter	Test conditions	Min.	Typ.	Max.	Unit
I_{CES}	Collector cut-off current (V_{BE} = 0)	V_{CE} = - 100 V		-	-20	µA
I_{CEO}	Collector cut-off current (I_B = 0)	V_{CB} = - 60 V		-	-50	µA
I_{EBO}	Emitter cut-off current (I_C = 0)	V_{EB} = - 5 V		-	-0.1	mA
$V_{CEO(sus)}$ (1)	Collector-emitter sustaining voltage (I_B = 0)	I_C = - 30 mA	-100	-		V
$V_{CE(sat)}$ (1)	Collector-emitter saturation voltage	I_C = - 3 A I_B = - 375 mA		-	-1.2	V
$V_{BE(on)}$ (1)	Base-emitter on voltage	I_C = - 3 A V_{CE} = - 4 V		-	-1.8	V
h_{FE}	DC current gain	I_C = - 1 A V_{CE} = - 4 V I_C = - 3 A V_{CE} = - 4 V	25 10	-	 50	

1. Pulse test: pulse duration ≤300 µs, duty cycle ≤2 %

2.1 Electrical characteristic (curves)

Figure 2. Safe operating area

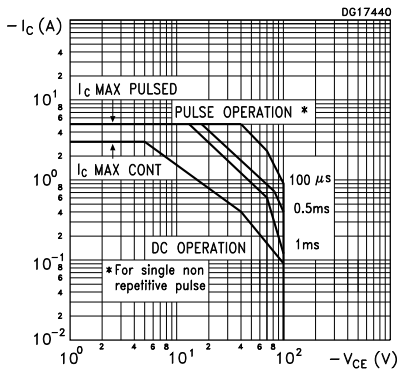


Figure 3. Derating curve

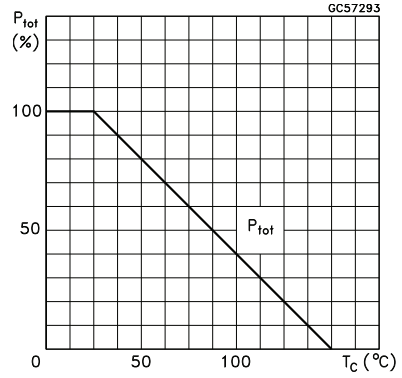


Figure 4. DC current gain (V_{CE} = - 2 V)

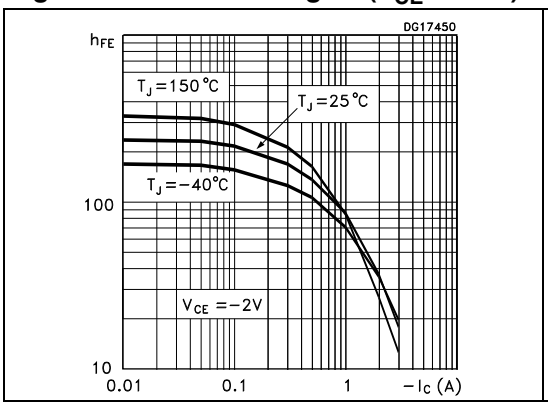


Figure 5. DC current gain (V_{CE} = - 4 V)

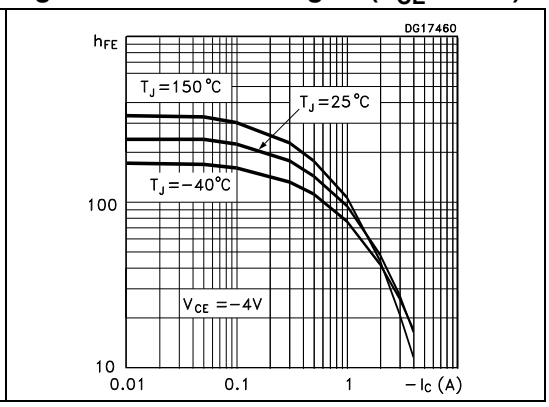


Figure 6. Collector-emitter saturation voltage

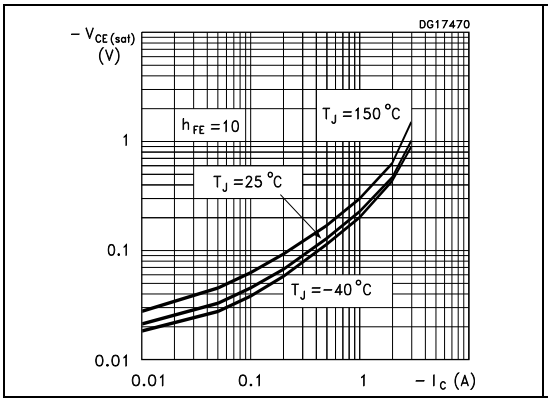


Figure 7. Base-emitter saturation voltage

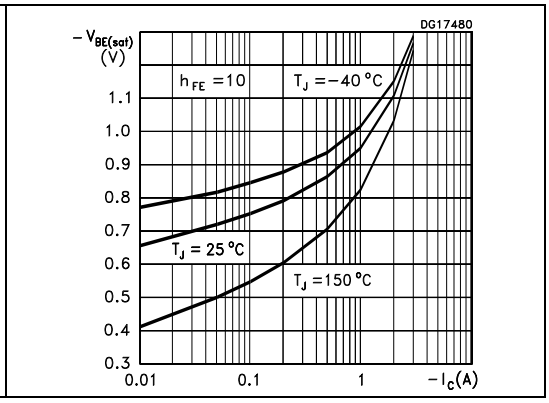


Figure 8. Base-emitter on voltage

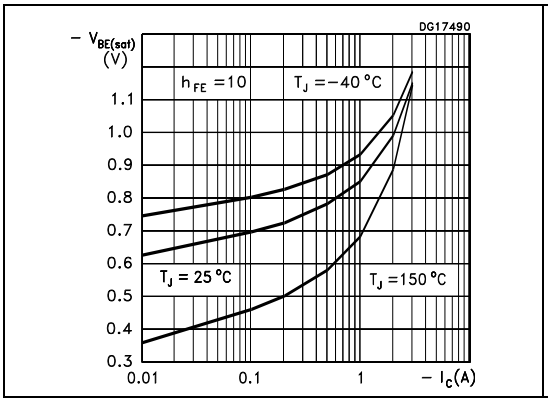


Figure 9. Resistive load switching time (on)

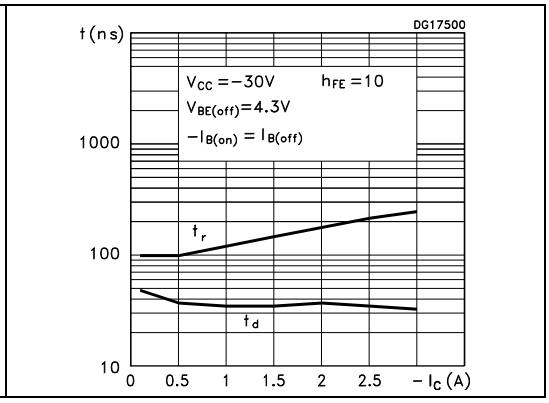
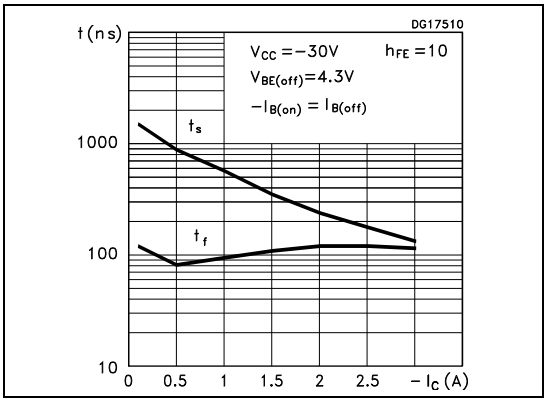
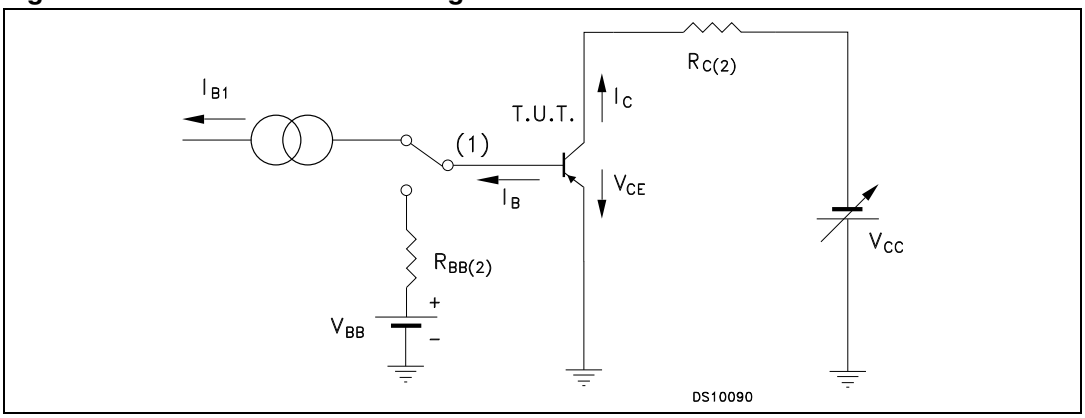


Figure 10. Resistive load switching time (off)



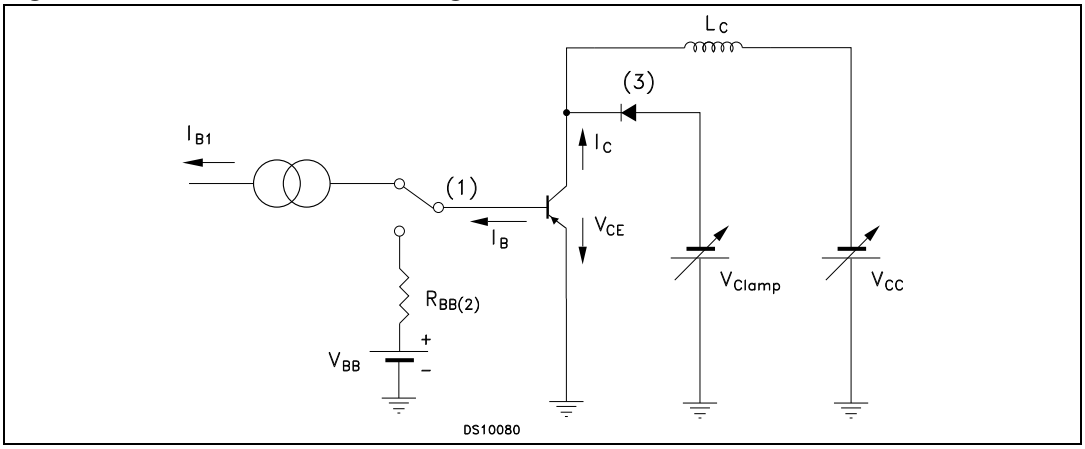
2.2 Test circuits

Figure 11. Resistive load switching test circuit



1. Fast electronic switch
2. Non-inductive resistor

Figure 12. Inductive load switching test circuit



1. Fast electronic switch
2. Non-inductive resistor
3. Fast recovery rectifier

3 Package mechanical data

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Table 5. DPAK (TO-252) mechanical data

Dim.	mm		
	Min.	Typ.	Max.
A	2.20		2.40
A1	0.90		1.10
A2	0.03		0.23
b	0.64		0.90
b4	5.20		5.40
c	0.45		0.60
c2	0.48		0.60
D	6.00		6.20
D1		5.10	
E	6.40		6.60
E1		4.70	
e		2.28	
e1	4.40		4.60
H	9.35		10.10
L	1		1.50
L1		2.80	
L2		0.80	
L4	0.60		1
R		0.20	
V2	0°		8°

Figure 13. DPAK (TO-252) drawing

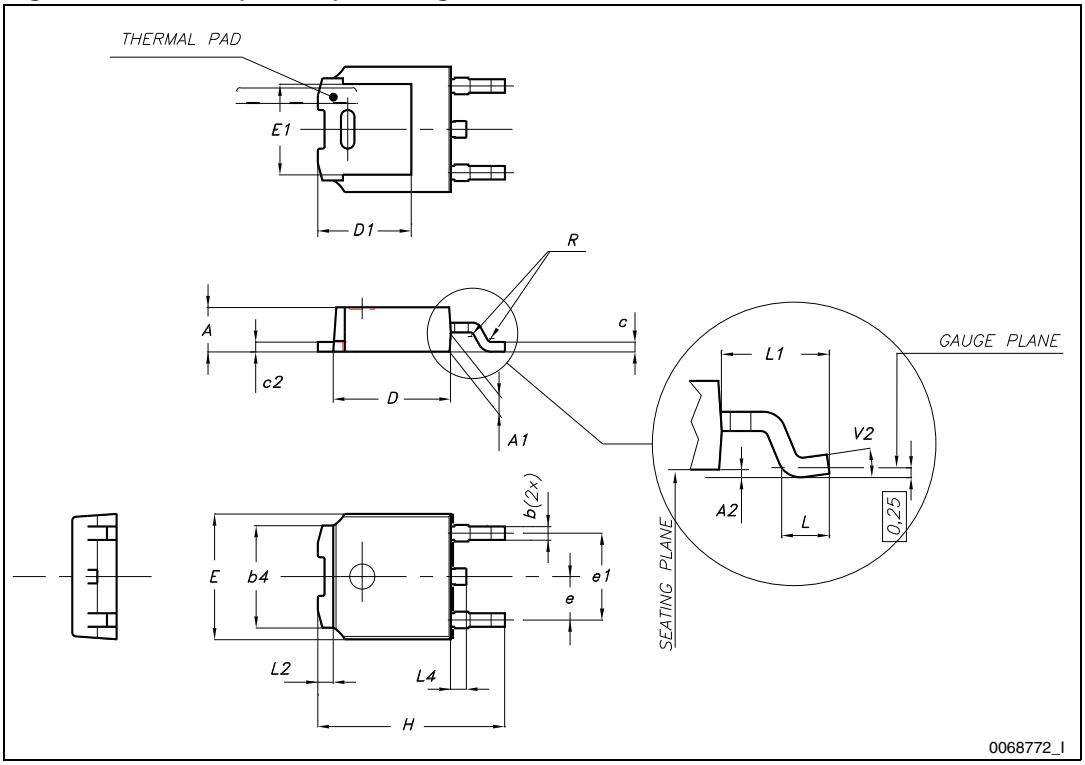
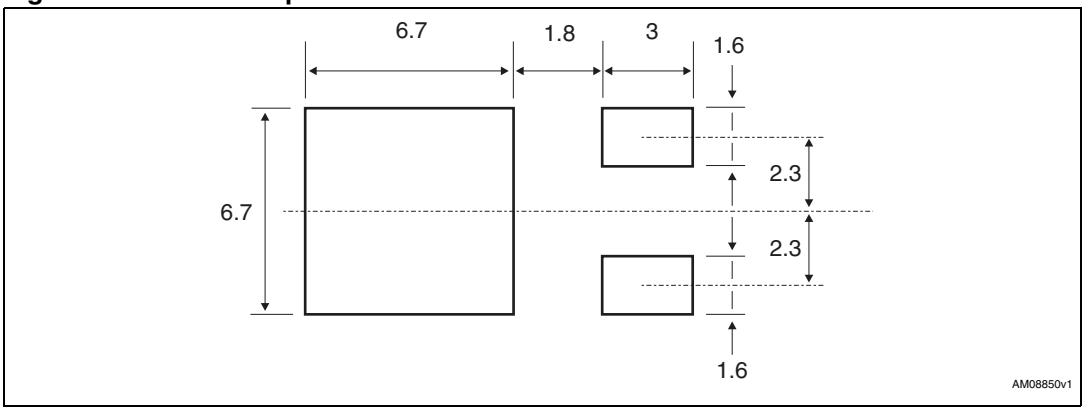


Table 6. DPAK (TO-252) tape and reel mechanical data

Tape			Reel		
Dim.	mm		Dim.	mm	
	Min.	Max.		Min.	Max.
A0	6.8	7	A		330
B0	10.4	10.6	B	1.5	
B1		12.1	C	12.8	13.2
D	1.5	1.6	D	20.2	
D1	1.5		G	16.4	18.4
E	1.65	1.85	N	50	
F	7.4	7.6	T		22.4
K0	2.55	2.75			
P0	3.9	4.1	Base qty.		2500
P1	7.9	8.1	Bulk qty.		2500
P2	1.9	2.1			
R	40				
T	0.25	0.35			
W	15.7	16.3			

Figure 14. DPAK footprint[a]



a. All dimensions are in millimeters

Figure 15. Tape for DPAK (TO-252)

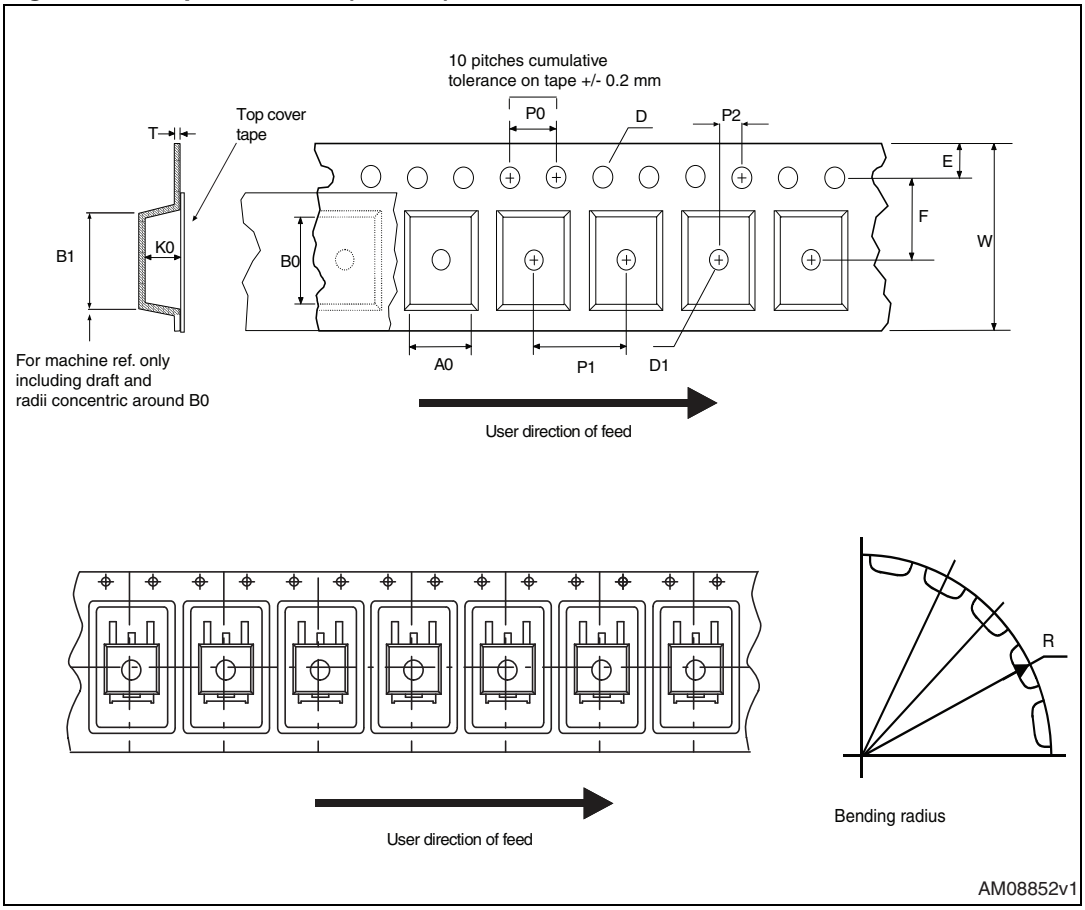
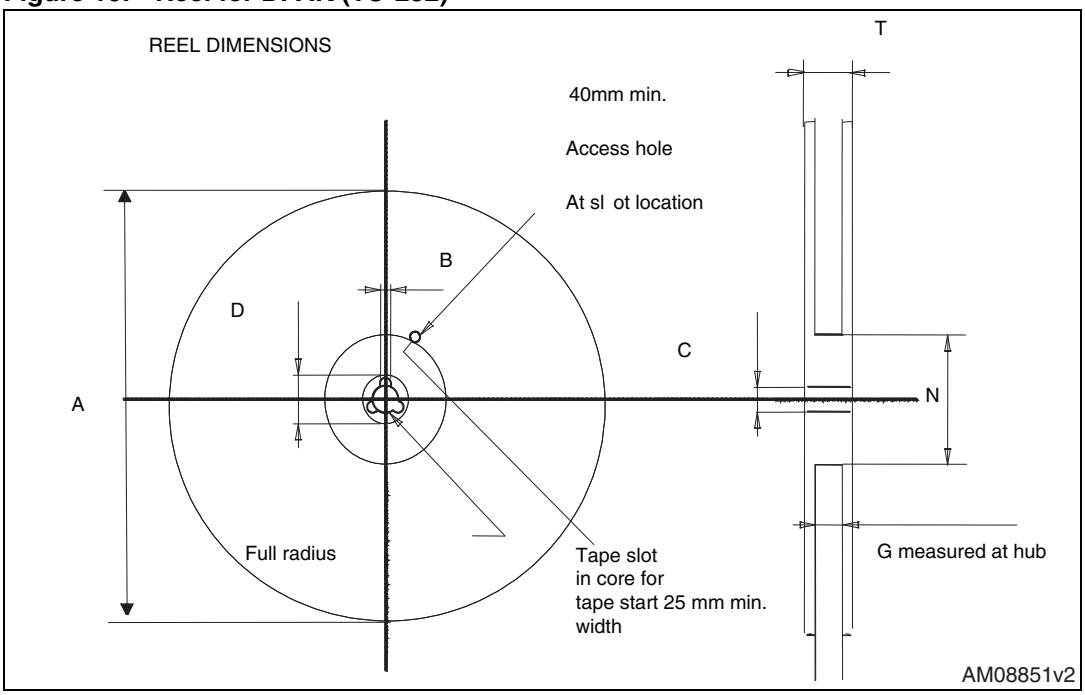


Figure 16. Reel for DPAK (TO-252)



4 Revision history

Table 7. Document revision history

Date	Revision	Changes
01-Jun-2007	1	Initial release.
09-Nov-2009	2	Updated package mechanical data.
14-Jan-2010	3	Modified *Table 3 on page 2*.
19-Jun-2012	4	Modified: mechanical data updated

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